

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants

Kohei TATSUMI, et al.

Serial No. : 09/254,118

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For

: METHOD OF PARTIALLY PLATING SUBSTRATE

FOR ELECTRONIC DEVICES

Assistant Commissioner for Patents Washington, D.C. 20231

## SUBMISSION OF ORIGINAL DECLARATION

## SIR:

Applicants submit herewith an original executed Declaration and Power of Attorney, identified by the international application serial number and filing date, in the above-identified application.

The Office is hereby authorized to charge any fees required by this paper to Deposit Account No. 11-0600. This paper is filed in duplicate.

Thereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Paterts and Trademarks, Washington, D.C. 20231, on

Date april 12/187 Atty's Reg. # 18,918

Atty's Signature <u></u>

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April 12, 1999 Dated: L:\NY2DOCS\EWG\PU01\76523-1

Respectfully submitted,

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for the same

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